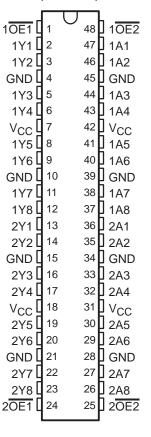
SCAS569G - MARCH 1996 - REVISED JUNE 1998

- Member of the Texas Instruments Widebus™ Family
- EPIC™ (Enhanced-Performance Implanted CMOS) Submicron Process
- Typical V<sub>OLP</sub> (Output Ground Bounce)
  < 0.8 V at V<sub>CC</sub> = 3.3 V, T<sub>A</sub> = 25°C
- Typical V<sub>OHV</sub> (Output V<sub>OH</sub> Undershoot)
  2 V at V<sub>CC</sub> = 3.3 V, T<sub>A</sub> = 25°C
- Supports Mixed-Mode Signal Operation on All Ports (5-V Input/Output Voltage With 3.3-V V<sub>CC</sub>)
- Power Off Disables Outputs, Permitting Live Insertion
- Latch-Up Performance Exceeds 250 mA Per JESD 17
- Bus Hold on Data Inputs Eliminates the Need for External Pullup/Pulldown Resistors
- Package Options Include Plastic 300-mil Shrink Small-Outline (DL) and Thin-Shrink Small-Outline (DGG) Packages

#### description

This 16-bit buffer/driver is designed for 1.65-V to 3.6-V V<sub>CC</sub> operation, and provides a high-performance bus interface for wide data paths.

DGG OR DL PACKAGE (TOP VIEW)



The 3-state control gate is a 2-input AND gate with active-low inputs so that if either output-enable ( $\overline{OE1}$  or  $\overline{OE2}$ ) input is high, all corresponding outputs are in the high-impedance state.

Inputs can be driven from either 3.3-V or 5-V devices. This feature allows the use of these devices as translators in a mixed 3.3-V/5-V system environment.

To ensure the high-impedance state during power up or power down,  $\overline{OE}$  should be tied to  $V_{CC}$  through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

Active bus-hold circuitry is provided to hold unused or floating data inputs at a valid logic level.

The SN74LVCH16540A is characterized for operation from -40°C to 85°C.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

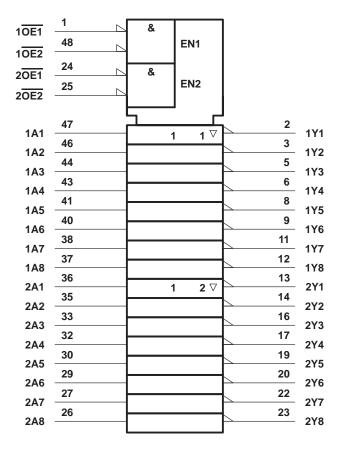
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# FUNCTION TABLE (each 8-bit section)

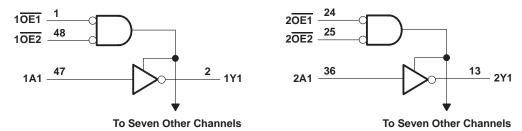
	INPUTS	OUTPUT		
OE1	OE2	Α	Y	
L	L	L	Н	
L	L	Н	L	
Н	X	Χ	Z	
Х	Н	Χ	z	

## logic symbol†



<sup>&</sup>lt;sup>†</sup> This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

### logic diagram (positive logic)





SCAS569G - MARCH 1996 - REVISED JUNE 1998

### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage range, V <sub>CC</sub>	0.5 V to 6.5 V
Input voltage range, V <sub>I</sub> (see Note 1)	–0.5 V to 6.5 V
Voltage range applied to any output in the high-impedance or power-off state, VO	
(see Note 1)	–0.5 V to 6.5 V
Voltage range applied to any output in the high or low state, VO	
(see Notes 1 and 2)	0.5 V to V <sub>CC</sub> + 0.5 V
Input clamp current, I <sub>IK</sub> (V <sub>I</sub> < 0)	–50 mA
Output clamp current, I <sub>OK</sub> (V <sub>O</sub> < 0)	–50 mA
Continuous output current, IO	±50 mA
Continuous current through each V <sub>CC</sub> or GND	±100 mA
Package thermal impedance, θ <sub>JA</sub> (see Note 3): DGG package	89°C/W
DL package	94°C/W
Storage temperature range, T <sub>stg</sub>	–65°C to 150°C

<sup>†</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input negative-voltage and output voltage ratings may be exceeded if the input and output current ratings are observed.

- 2. The value of V<sub>CC</sub> is provided in the recommended operating conditions table.
- 3. The package thermal impedance is calculated in accordance with JESD 51.

### recommended operating conditions (see Note 4)

			MIN	MAX	UNIT	
VCC	Supply voltage	Operating	1.65	3.6	V	
	Supply voltage	Data retention only	1.5		V	
		V <sub>CC</sub> = 1.65 V to 1.95 V	0.65 × V <sub>CC</sub>			
VIH	High-level input voltage	$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	1.7		V	
		$V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$	2			
		V <sub>CC</sub> = 1.65 V to 1.95 V		0.35 × V <sub>CC</sub>		
$V_{IL}$	Low-level input voltage	$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$		0.7	V	
		$V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$		0.8		
٧ <sub>I</sub>	Input voltage		0	5.5	V	
	Output voltage	High or low state	0	VCC	V	
۷O		3 state	0	5.5	V	
	High-level output current	V <sub>CC</sub> = 1.65 V		-4	mA	
lou		V <sub>CC</sub> = 2.3 V		-8		
ЮН		V <sub>CC</sub> = 2.7 V		-12		
		V <sub>CC</sub> = 3 V		-24		
		V <sub>CC</sub> = 1.65 V		4		
lOL	Low-level output current	V <sub>CC</sub> = 2.3 V		8	mA	
		V <sub>CC</sub> = 2.7 V		12		
		V <sub>CC</sub> = 3 V		24		
Δt/Δν	Input transition rise or fall rate	_	0	10	ns/V	
TA	Operating free-air temperature		-40	85	°C	

NOTE 4: All unused control inputs of the device must be held at V<sub>CC</sub> or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.



## **SN74LVCH16540A 16-BIT BUFFER/DRIVER WITH 3-STATE OUTPUTS**

SCAS569G - MARCH 1996 - REVISED JUNE 1998

#### electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS		Vcc	MIN	TYP	MAX	UNIT	
	I <sub>OH</sub> = -100 μA	1.65 V to 3.6 V	V <sub>CC</sub> -0.2			٧		
	I <sub>OH</sub> = -4 mA	1.65 V	1.2					
Vall	I <sub>OH</sub> = -8 mA	2.3 V	1.7					
VOH	lou - 12 mA		2.7 V	2.2				
	10H = -12 IIIA	I <sub>OH</sub> = -12 mA						
	I <sub>OH</sub> = -24 mA		3 V	2.2			.	
	I <sub>OL</sub> = 100 μA		1.65 V to 3.6 V			0.2		
	$I_{OL} = 4 \text{ mA}$		1.65 V			0.45		
VOL	I <sub>OL</sub> = 8 mA		2.3 V			0.7	V	
	I <sub>OL</sub> = 12 mA		2.7 V			0.4		
	I <sub>OL</sub> = 24 mA		3 V			0.55		
lį	V <sub>I</sub> = 0 to 5.5 V		3.6 V			±5	μΑ	
	V <sub>I</sub> = 0.58 V	1.65 V	‡			μА		
	V <sub>I</sub> = 1.07 V	1.05 V	‡					
	V <sub>I</sub> = 0.7 V	2.3 V	45					
I <sub>I</sub> (hold)	V <sub>I</sub> = 1.7 V	2.5 V	-45					
	V <sub>I</sub> = 0.8 V	3 V	75					
	V <sub>I</sub> = 2 V	3 V	<del>-</del> 75					
	V <sub>I</sub> = 0 to 3.6 V§	3.6 V			±500			
l <sub>off</sub>	$V_I$ or $V_O = 5.5 V$		0			±10	μΑ	
I <sub>OZ</sub>	V <sub>O</sub> = 0 to 5.5 V	$V_{O} = 0 \text{ to } 5.5 \text{ V}$				±10	μΑ	
laa	V <sub>I</sub> = V <sub>CC</sub> or GND	10 0	3.6 V		20		^	
Icc	$3.6 \text{ V} \leq \text{V}_{\text{I}} \leq 5.5 \text{ V}^{\P}$	IO = 0	3.6 V			20	μΑ	
ΔICC	One input at $V_{CC}$ – 0.6 V, Other inputs at $V_{CC}$ or GND		2.7 V to 3.6 V			500	μА	
C <sub>i</sub>	V <sub>I</sub> = V <sub>CC</sub> or GND		3.3 V		5		pF	
Co	V <sub>O</sub> = V <sub>CC</sub> or GND		3.3 V		6.5		pF	

# switching characteristics over recommended operating free-air temperature range (unless otherwise noted) (see Figures 1 through 3)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	V <sub>CC</sub> = ± 0.1			V <sub>CC</sub> = 2.7 V		V <sub>CC</sub> = 3.3 V ± 0.3 V		UNIT	
	(INI O1)	(0011 01)	MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX	
tpd	А	Υ	‡	‡	‡	‡		4.5	1	3.7	ns
t <sub>en</sub>	ŌĒ	Υ	‡	‡	‡	‡		5.9	1.5	4.8	ns
t <sub>dis</sub>	ŌĒ	Y	‡	‡	‡	‡		6.3	1.6	5.9	ns

<sup>‡</sup> This information was not available at the time of publication.



<sup>†</sup> All typical values are at  $V_{CC}$  = 3.3 V,  $T_A$  = 25°C. ‡ This information was not available at the time of publication.

<sup>§</sup> This is the bus-hold maximum dynamic current required to switch the input from one state to another.

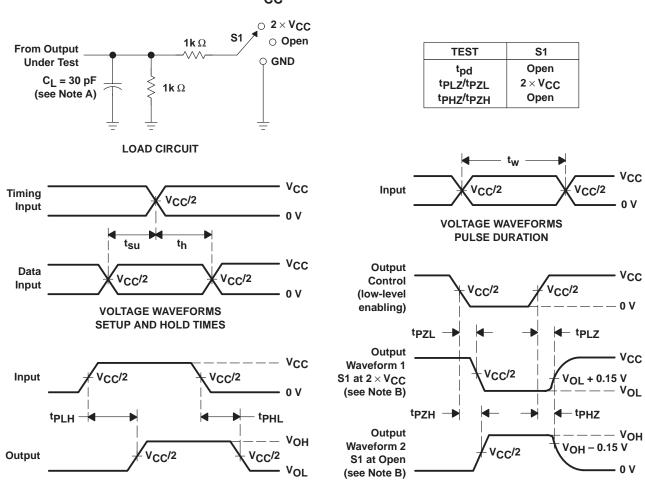
<sup>¶</sup> This applies in the disabled state only.

# operating characteristics, $T_A = 25^{\circ}C$

PARAMETER			TEST CONDITIONS	V <sub>CC</sub> = 1.8 V ± 0.15 V	V <sub>CC</sub> = 2.5 V ± 0.2 V	V <sub>CC</sub> = 3.3 V ± 0.3 V	UNIT
		CONDITIONS	TYP	TYP	TYP		
Power dissipation capacitance	Outputs enabled	f = 10 MHz	†	†	34	рF	
Сра	C <sub>pd</sub> per buffer/driver	Outputs disabled	1 = 10 MH2	†	†	2	рг

<sup>†</sup> This information was not available at the time of publication.

#### PARAMETER MEASUREMENT INFORMATION $V_{CC} = 1.8 V \pm 0.15 V$



- NOTES: A. C<sub>L</sub> includes probe and jig capacitance.
  - B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.

**VOLTAGE WAVEFORMS** 

**ENABLE AND DISABLE TIMES** 

- C. All input pulses are supplied by generators having the following characteristics: PRR  $\leq$  10 MHz,  $Z_O = 50 \Omega$ ,  $t_f \leq$  2 ns.  $t_f \leq$  2 ns.
- D. The outputs are measured one at a time with one transition per measurement.
- E. tpLZ and tpHZ are the same as tdis.

**VOLTAGE WAVEFORMS** 

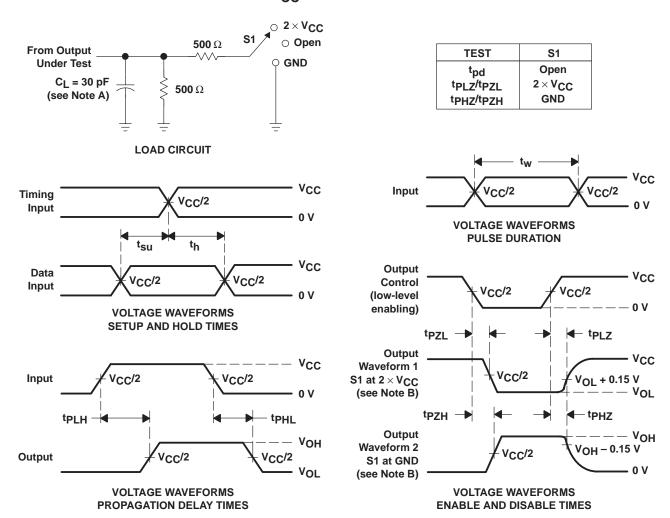
**PROPAGATION DELAY TIMES** 

- F. tpzL and tpzH are the same as ten.
- G. tpLH and tpHL are the same as tpd.

Figure 1. Load Circuit and Voltage Waveforms



# PARAMETER MEASUREMENT INFORMATION $V_{CC} = 2.5 \text{ V} \pm 0.2 \text{ V}$

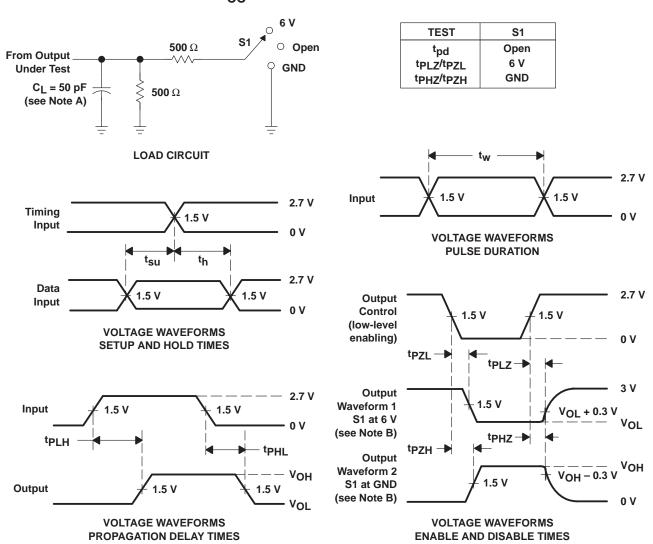


NOTES: A. C<sub>L</sub> includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR  $\leq$  10 MHz,  $Z_O = 50 \Omega$ ,  $t_r \leq 2$  ns.  $t_f \leq 2$  ns.
- D. The outputs are measured one at a time with one transition per measurement.
- E. tpLz and tpHz are the same as tdis.
- F. tpzL and tpzH are the same as ten.
- G. tpLH and tpHL are the same as tpd.

Figure 2. Load Circuit and Voltage Waveforms

# PARAMETER MEASUREMENT INFORMATION $V_{CC}$ = 2.7 V AND 3.3 V $\pm$ 0.3 V



- NOTES: A. C<sub>I</sub> includes probe and jig capacitance.
  - B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
  - C. All input pulses are supplied by generators having the following characteristics: PRR  $\leq$  10 MHz,  $Z_O = 50 \Omega$ ,  $t_f \leq$  2.5 ns,  $t_f \leq$  2.5 ns.
  - D. The outputs are measured one at a time with one transition per measurement.
  - E. tpl 7 and tpHZ are the same as tdis.
  - F. tpzL and tpzH are the same as ten.
  - G. tpLH and tpHL are the same as tpd.

Figure 3. Load Circuit and Voltage Waveforms



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